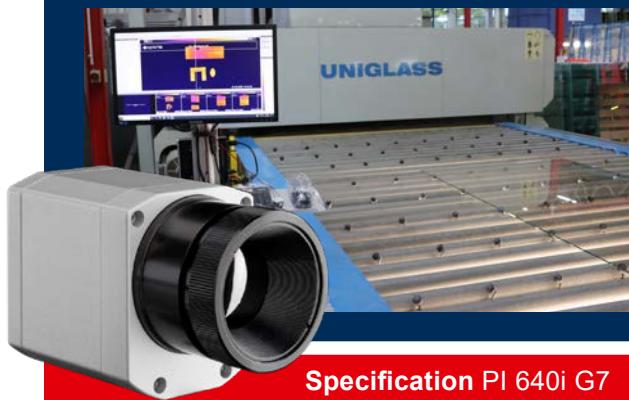


### High resolution Bottom up glass inspection system for process control in glass tempering machines



### Features

- Compact bottom up system for coating independent underneath measurement
- Excellent 1600 px resolution on maximum 4.3 m scan width (@ 90 cm distance)
- Integrated ultra-fast glass breakage detection combined with Digitally controlled lens protection system (DCLP)
- No cooling or air purge requirement
- Glass area calculation
- Pre-assembled system for easy installation on glass tempering furnaces

Specification PI 640i G7		Specification glass breakage sensor CTlaser 4ML	
Optical resolution	640 x 480 pixels	Temperature range	0 °C ... 500 °C
Detector	FPA, uncooled (17 µm x 17 µm)	Spectral range	2.2 - 6 µm
Spectral range	7.9 µm	Optical resolution (90 % energy)	30:1
Temperature ranges	150 ... 900 °C, 200 ... 1500 °C	System accuracy <sup>3)</sup> (at T <sub>Amb</sub> 23 ± 5 °C)	± (0.3% of reading +2 °C)
Sighting range	0 ... 250 °C	Temperature resolution (NETD) <sup>4)</sup>	120 mK
Frame rate	32 Hz / 125 Hz @ 640 x 120 pixels	Exposure time	90 µs (90% signal)
Optics (FOV)	90° x 66° FOV / f = 7.7 mm or 60° x 45° FOV / f = 10.5 mm max. FOV: 111°/ 1600 pixels per scan line <sup>1)</sup> 4.3 m scan width @ 90 cm distance	Response time	300 µs (90% signal)
Thermal sensitivity (NETD) <sup>2)</sup>	80 mK (at T <sub>Obj</sub> = 650 °C)	Emissivity/Gain (adjustable via programming keys or software)	0.100 – 1.100
Accuracy	±2 °C or ±2 %, whichever is greater	Environmental rating	IP 65 (NEMA-4)
PC interface	USB 2.0 / USB to GigE (PoE) interface	Ambient temperature <sup>5)</sup>	-20 °C ... 70 °C (sensing head: 50 °C with laser on) 0 °C ... 85 °C (electronics)
Process interface (PIF), industrial	2x 0 – 10 V input, digital input (max. 24 V), 3x 0/4 – 20 mA output, 3x relais (0 – 30 V/ 400 mA), fail-safe relay	Vibration (sensor)	IEC 60068-2-6 / -64
Ambient temperature	0 ... 50 °C	Shock (sensor)	IEC 60068-2-27 (25 G and 50 G)
Relative humidity	20 – 80 %, non-condensing	Weight	600 g (sensing head) 420 g (electronics)
Enclosure (size / rating)	46 x 56 x 76 – 100 mm (depending on lens + focus position) / IP 67 (NEMA)	1) With 90° optics and usage of a diagonal scan line; maximum pixel count based on two cameras without overlapping 2) Measurement of the noise equivalent temperature difference (NETD) according to VDI 5585 standard, method B; 650 °C black body temperature, frame rate 20 Hz averaged 3) ε = 1, response time 1 s 4) At time constant 1 ms and T <sub>Obj</sub> = 50 °C 5) The functioning of the LCD display may be limited at ambient temperatures below 0 °C	
Weight	269 - 340 g (depending on lens)		
Vibration	IEC 60068-2-6 / -64		
Shock	IEC 60068-2-27 (25 G and 50 G)		

### Scope of supply Bottom Up GIS 640i G7

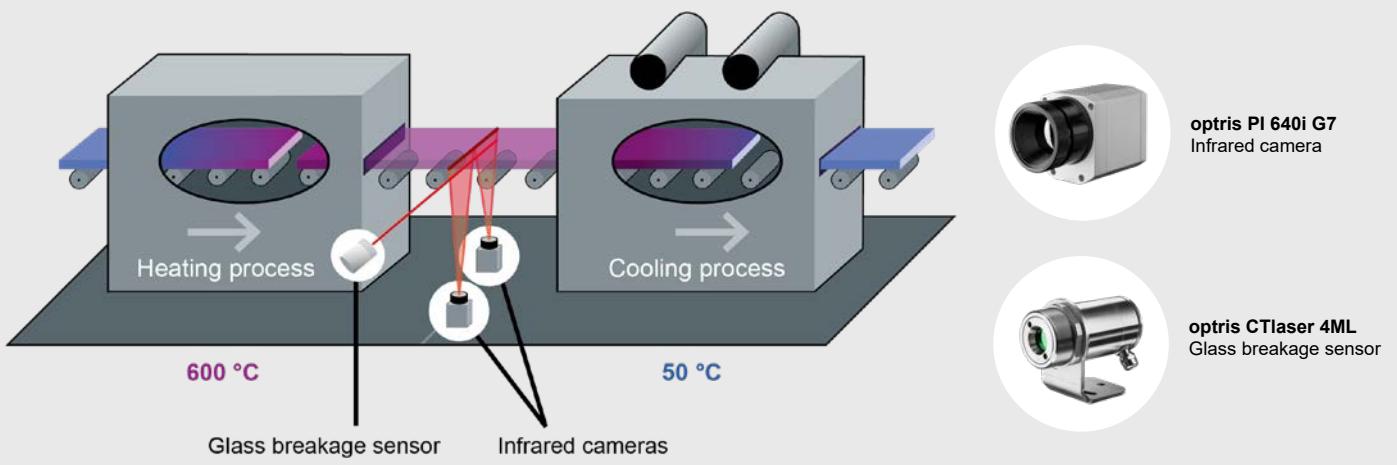
- 2x PI 640i G7 imager with 90° or 60° FOV
- 2x Industrial Process Interface
- CTlaser 4ML glass breakage sensor with USB interface
- 2x DCLP Shutter system with mounting brackets for imagers
- 2x USB Server Gigabit
- Control cabinet with cable set (10 m each) and remote control box
- Software package
- 100-230 V AC/ 24 V DC power supply for initial start-up



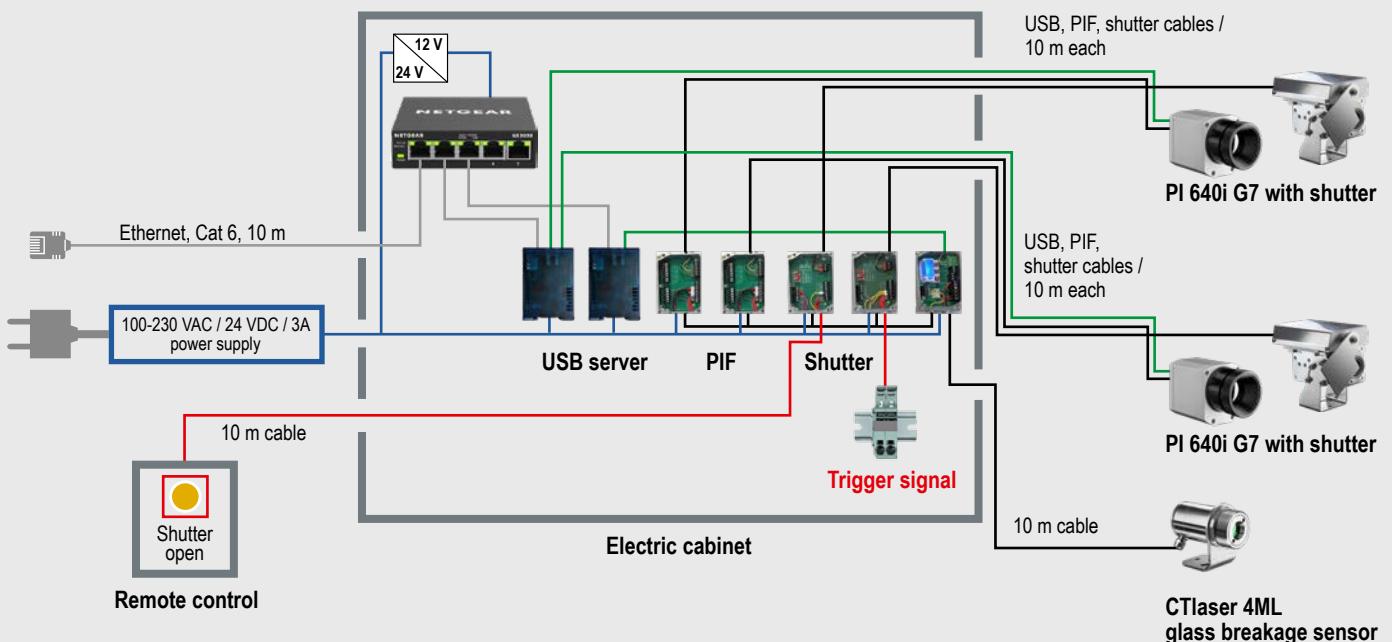
# optris Bottom Up GIS 640i G7

## TECHNICAL DATA

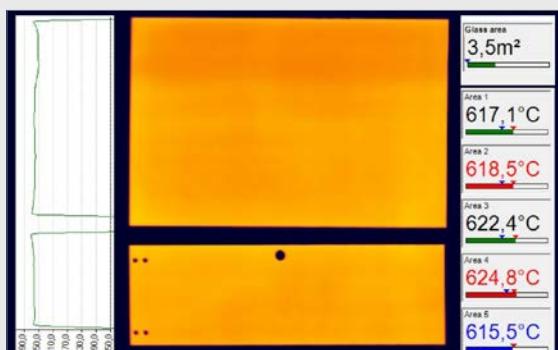
### Measurement principle



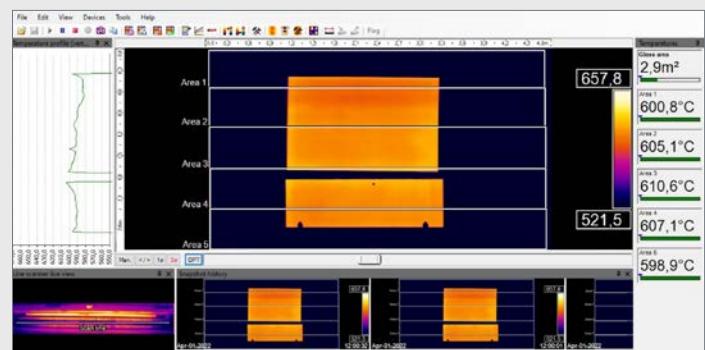
### System overview



### Software PIX Connect



The software provides excellent image quality and manifold analysis features as profiles, measurement areas and alarm indication



Exemplary software layout with thermal profile, IR live view, snapshot history, five measurement zones and glass area calculation